

SILICON TRANSISTOR 2SA1412-Z

PNP SILICON TRIPLE DIFFUSED TRANSISTOR MP-3

DESCRIPTION

2SA1412-Z is designed for High Voltage Switching, especially in Hybrid Integrated Circuits.

FEATURES

High Voltage: VcEo = −400 V

• High Speed : $t_f \le 0.7 \mu s$

Complement to 2SC3631-Z

QUALITY GRADE

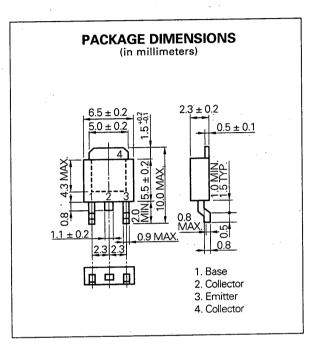
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Collector to Base Voltage	Vсво	-400	٧
Collector to Emitter Voltage	Vceo	-400	٧
Emitter to Base Voltage	Vево	-7	٧
Collector Current (DC)	Ic	-2.0	Α
Collector Current (Pulse)*	lc ·	-4.0	Α
Total Power Dissipation (Ta = 25 °C)**	PT	2.0	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg -	55 to +150	°C

- * PW ≦ 10 ms, Duty Cycle ≦ 50 %
- ** When mounted on ceramic substrate of 7.5 cm $^2 \times 0.7$ mm



ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

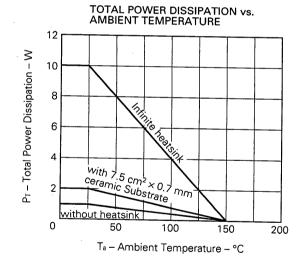
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CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	Ісво			-10	μΑ	Vcs = -400 V, IE = 0
Emitter Cutoff Current	Ієво			-10	μΑ	VEB = -5.0 V, Ic = 0
DC Current Gain	hFE1*	40	60	120		Vce = -5.0 V, Ic = -0.1 A
DC Current Gain	h _{FE2} *	10	22			Vce = -5.0 V, Ic = -1.0 A
Collector Saturation Voltage	VCE(sat)*		-0.25	-0.5	V	Ic = -0.5 A, I _B = -0.1 A
Base Saturation Voltage	VBE(sat)*		-0.85	-1.2	V	Ic = -0.5 A, I _B = -0.1 A
Gain Bandwidth Product	fτ		40		MHz	Vce = -10 V, le = -100 mA
Output Capacitance	Сов		30		pF	Vcs = -10 V, IE = 0, f = 1.0 MH
Turn-on Time	ton		0.03	0.5	μs	
Storage Time	İ stg		1.4	2.0	μs	Ic = -1.0 A, R _L = 150 Ω IB ₁ = -1B ₂ = -0.2 A,
Fall time	tr		0.1	0.7	μs	Vcc = -150 V

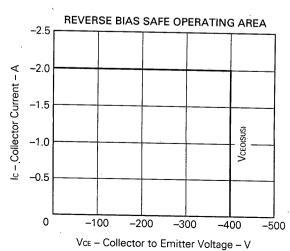
^{*} Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2 %

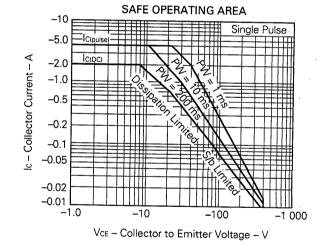
hre Classification

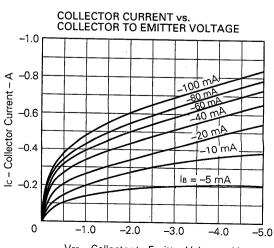
MARKING	L	K	
hFE1	40 to 80	60 to 120	

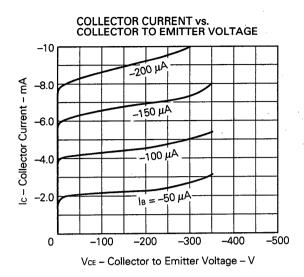
TYPICAL CHARACTERISTICS (Ta = 25 °C)



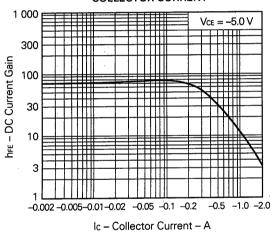




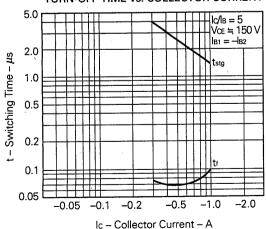




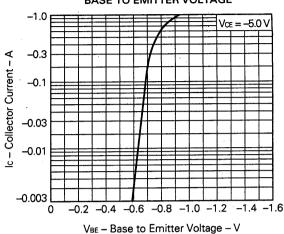




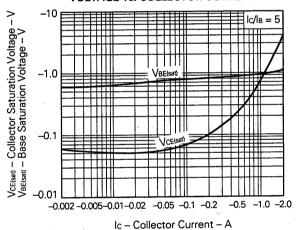
TURN-OFF TIME vs. COLLECTOR CURRENT



COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



COLLECTOR AND BASE SATURATION VOLTAGE vs. COLLECTOR CURRENT



Reference

Application note name	No.
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207
Design of Push-Pull Type Switching Regulators (Basic).	TEB-1002
Design of Push-Pull Type Switching Regulators (Applications).	TEB-1003
Optimum Base Drive Conditions of Switching Power Transistors.	TEB-1014

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Application examples recommended by NEC Corporation.

Standard: Computer, Office equipment, Communication equipment, Test and Measurement equipment, Machine tools, Industrial robots, Audio and Visual equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Traffic control systems, Antidisaster systems, Anticrime systems, etc.